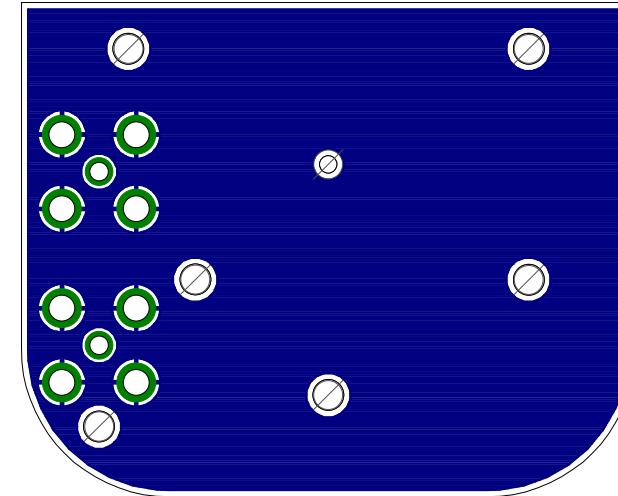


Top View



Bottom View (mostly copper)

Substrate: **0.004 in** RO4350b

8.27 mil wide, 35 um thick copper trace on component (top) layer

35 um thick copper on ground (back) layer

A **1.20 mm** non-plated through hole (NPTH) through the entire PCB, with the copper trace running around the top of the hole as shown.

6 non-plated through holes (NPTH) for mounting the PCB (0.083 inch diameter) and several pads for mount SMA connectors.

Immersion gold finish on both sides, no silkscreen, no solder mask.